

Title of Document:	<b>REPORT</b>	Issue No. G22-05690	Rev. 0
Customer:		Issue date: September 8, 2022	
Title subject:	ZE connector Wafer: Notification of completion of acquiring overseas standard (UL) certification for the additional resin material products		Revision date:

It is informed that the certification of the overseas standard for the ZE connector Wafer made of additional resin material has been completed as follows.

**1. Target product and Part Number**

Series	Part name	Part number	UL Certification
ZE	Header Top entry type	B**B-ZESK-D(SU) (T)(LF)(SN)(N) B**B-ZESK-1D(SU) (T)(LF)(SN)(N)	Registration complete

Note) Number of circuits in one or two-digit figures is indicated in \*.

Your thought understanding and consideration would be very much appreciated.

-End-

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